

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

01005

NPO/X5R/X7R

4 V TO 25 V

0.5 pF to 470 nF

RoHS compliant & Halogen Free



SCOPE

This specification describes 01005 NP0/X5R series chip capacitors with lead-free terminations.

APPLICATIONS

- Mobile
- Module

FEATURES

- Supplied in tape on reel
- Nickel-barrier end termination
- RoHS compliant
- Halogen Free compliant

ORDERING INFORMATION - GLOBAL PART NUMBER, PHYCOMP CTC & I2NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

CC XXXX X X XXX X **B** X XXX
 (1) (2) (3) (4) (5) (6) (7)

(1) SIZE – INCH BASED (METRIC)

0100(0402)

(2) TOLERANCE

- B = ±0.1pF
- C = ±0.25pF
- D = ±0.5pF
- J = ±5%
- K = ±10%
- M = ±20%

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

(4) TC MATERIAL

- NPO
- X5R
- X7R

(5) RATED VOLTAGE

- 4 = 4 V
- 5 = 6.3V
- 6 = 10 V
- 7 = 16 V
- 8 = 25 V

(6) PROCESS

- N = NPO
- B = Class 2 MLCC

(7) CAPACITANCE VALUE

2 significant digits+number of zeros
 The 3rd digit signifies the multiplying factor, and letter R is decimal point
 Example: 121 = 12 × 10¹ = 120 pF

CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

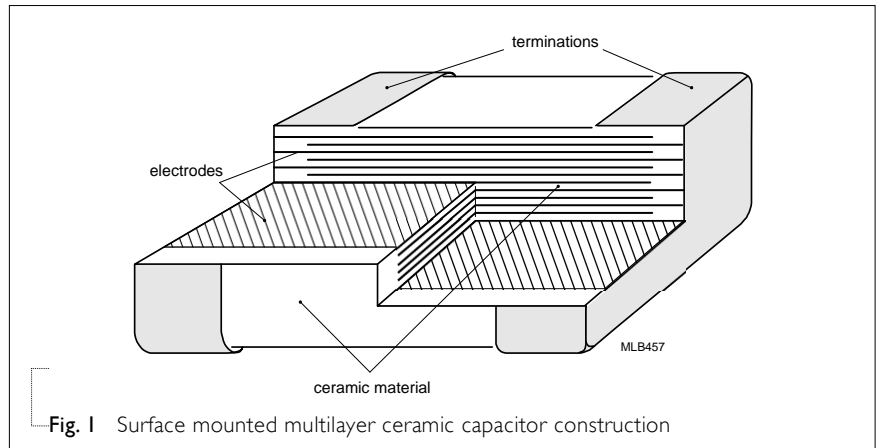


Fig. 1 Surface mounted multilayer ceramic capacitor construction

DIMENSION

Table I For outlines see fig. 2

| TYPE | L ₁ (mm) | W (mm) | T (mm) | L ₂ / L ₃ (mm) | | L ₄ (mm) |
|-------|---------------------|-----------|-----------|--------------------------------------|------|---------------------|
| | | | | min. | max. | min. |
| 01005 | 0.4 ±0.02 | 0.2 ±0.02 | 0.2 ±0.02 | 0.07 | 0.14 | 0.13 |

OUTLINES

For dimension see Table I

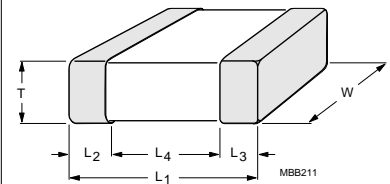


Fig. 2 Surface mounted multilayer ceramic capacitor dimension

CAPACITANCE RANGE & THICKNESS

| CAP. | NP0 | | CAP. | X5R | | | | CAP. | X7R | |
|------------|-------------|----------|------------|----------|----------|----------|----------|------------|------------|----------|
| | 16 V / 25 V | 50 V | | 4V | 6.3V | 10V | 16V | | 6.3V / 10V | 16V |
| 0.1 pF | 0.2±0.02 | 0.2±0.02 | 100 pF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 100 pF | 0.2±0.02 | 0.2±0.02 |
| 0.2 pF | 0.2±0.02 | 0.2±0.02 | 150 pF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 150 pF | 0.2±0.02 | 0.2±0.02 |
| 0.3 pF | 0.2±0.02 | 0.2±0.02 | 220 pF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 220 pF | 0.2±0.02 | 0.2±0.02 |
| 0.4 pF | 0.2±0.02 | 0.2±0.02 | 330 pF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 330 pF | 0.2±0.02 | 0.2±0.02 |
| 0.5 pF | 0.2±0.02 | 0.2±0.02 | 470 pF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 470 pF | 0.2±0.02 | 0.2±0.02 |
| 0.6 pF | 0.2±0.02 | 0.2±0.02 | 680 pF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 680 pF | 0.2±0.02 | 0.2±0.02 |
| 0.7 pF | 0.2±0.02 | 0.2±0.02 | 1 000 pF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | 1 000 pF | 0.2±0.02 | 0.2±0.02 |
| 0.75 pF | 0.2±0.02 | 0.2±0.02 | 2.2 nF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | | 2.2 nF | | |
| 0.8 pF | 0.2±0.02 | 0.2±0.02 | 4.7 nF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | | 4.7 nF | | |
| 0.9 pF | 0.2±0.02 | 0.2±0.02 | 10 nF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | | 10 nF | | |
| 1.0 pF | 0.2±0.02 | 0.2±0.02 | 22nF | 0.2±0.02 | 0.2±0.02 | | | 22nF | | |
| 1.2 pF | 0.2±0.02 | 0.2±0.02 | 47 nF | 0.2±0.02 | 0.2±0.02 | | | 47 nF | | |
| 1.5 pF | 0.2±0.02 | 0.2±0.02 | 100 nF | 0.2±0.02 | 0.2±0.02 | 0.2±0.02 | | 100 nF | | |
| 1.8 pF | 0.2±0.02 | 0.2±0.02 | 220 nF | 0.2±0.02 | 0.2±0.02 | | | 220 nF | | |
| 2.2 pF | 0.2±0.02 | 0.2±0.02 | Tape width | | 8 mm | | | Tape width | | 8 mm |
| 2.7 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 3.3 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 3.9 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 4.7 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 5.6 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 6.8 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 8.2 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 10 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 12 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 15 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 18 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 22 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 27 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 33 pF | 0.2±0.02 | 0.2±0.02 | | | | | | | | |
| 39 pF | 0.2±0.02 | | | | | | | | | |
| 47 pF | 0.2±0.02 | | | | | | | | | |
| 56 pF | 0.2±0.02 | | | | | | | | | |
| 68 pF | 0.2±0.02 | | | | | | | | | |
| 82 pF | 0.2±0.02 | | | | | | | | | |
| 100 pF | 0.2±0.02 | | | | | | | | | |
| Tape width | | 8 mm | | | | | | | | |

THICKNESS CLASSES AND PACKING QUANTITY

Table 3

| SIZE CODE | THICKNESS CLASSIFICATION | TAPE WIDTH QUANTITY PER REEL | Ø180 MM / 7 INCH | | Ø330 MM / 13 INCH | | QUANTITY PER BULK CASE |
|-----------|--------------------------|------------------------------|------------------|---------|-------------------|---------|------------------------|
| | | | Paper/PE | Blister | Paper/ | Blister | |
| 01005 | 0.2 ±0.02 mm | 8 mm | 20,000 | --- | --- | --- | --- |

ELECTRICAL CHARACTERISTICS

NP0/X5R DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 4

| DESCRIPTION | | VALUE |
|---|-----------|--|
| Capacitance range | | 0.5 pF to 470 nF |
| Capacitance tolerance | | |
| | C < 10 pF | ±0.1pF, ±0.25pF, ±0.5pF |
| NP0 | C ≥ 10 pF | ±5%, ±10% |
| X5R / X7R | | ±10%, ±20% |
| Dissipation factor (D.F.) | | |
| NP0 | C < 30 pF | ≤ 1 / (400 + 20C) |
| | C ≥ 30 pF | ≤ 0.1 % |
| X5R / X7R | | ≤ 10 % |
| Insulation resistance after 1 minute at U _r (DC) | | R _{ins} ≥ 10 GΩ or R _{ins} × C ≥ 500Ω · F whichever is less X5R/X7R > 10nF: R _{ins} × C ≥ 50Ω · F |
| Maximum capacitance change as a function of temperature (temperature characteristic/coefficient): | | |
| NP0 | | ±30 ppm/°C |
| X5R / X7R | | ±15% |
| Operating temperature range: | | |
| NP0 | | -55 °C to +125 °C |
| X5R | | -55 °C to +85 °C |
| X7R | | -55 °C to +125 °C |

SOLDERING RECOMMENDATION

Table 5

| SOLDERING METHOD | SIZE 01005 |
|------------------|---------------|
| Reflow | Reflow only |
| Reflow/Wave | --- |

TESTS AND REQUIREMENTS

Table 6 Test procedures and requirements

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
|---------------------------------------|---------------------|---|----------------------------------|
| Mounting | IEC 60384-21/22 4.3 | The capacitors may be mounted on printed-circuit boards or ceramic substrates | No visible damage |
| Visual Inspection and Dimension Check | 4.4 | Any applicable method using × 10 magnification | In accordance with specification |
| Capacitance | 4.5.1 | <p>Class 1: f = 1 MHz for C ≤ 1 nF, measuring at voltage V_{rms} at 20 °C f = 1 KHz for C > 1 nF, measuring at voltage V_{rms} at 20 °C</p> <p>Class 2: C ≤ 1 nF f = 1 KHz, measuring at voltage V_{rms} at 20 °C</p> <p>C > 1 nF f = 1 KHz, rated voltage ≤ 6.3 V, measuring at voltage 0.5 V_{rms} at 20 °C f = 1 KHz, rated voltage > 10 V, measuring at voltage V_{rms} at 20 °C</p> | Within specified tolerance |
| Dissipation Factor (D.F.) | 4.5.2 | <p>Class 1: f = 1 MHz for C ≤ 1 nF, measuring at voltage V_{rms} at 20 °C f = 1 KHz for C > 1 nF, measuring at voltage V_{rms} at 20 °C</p> <p>Class 2: C ≤ 1 nF f = 1 KHz, measuring at voltage V_{rms} at 20 °C</p> <p>C > 1 nF f = 1 KHz, rated voltage ≤ 6.3 V, measuring at voltage 0.5 V_{rms} at 20 °C f = 1 KHz, rated voltage > 10 V, measuring at voltage V_{rms} at 20 °C</p> | In accordance with specification |
| Insulation Resistance | 4.5.3 | At Ur (DC) for 1 minute | In accordance with specification |

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS | | | | | | | | | |
|-------------------------|-----------------------|---|--|------|-----------------|---|------|---|-----------------------|---|------|---|
| Temperature coefficient | 4.6 | Capacitance shall be measured by the steps shown in the following table. The capacitance change should be measured after 5 min at each specified temperature stage. | $\Delta C/C$ Class I (NP0): $\pm 30\text{ppm}$ Class 2: (X7R/X5R): $\pm 15\%$ In case of applying voltage, the capacitance change should be measured after 1 more min. with applying voltage in equilibration of each temp. stage. CC0100MRX5R4(5)BB104(224): $0.2V \pm 0.1V_{rms}$ | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature(°C)</th> </tr> </thead> <tbody> <tr> <td>a</td> <td>25±2</td> </tr> <tr> <td>b</td> <td>Lower temperature±3°C</td> </tr> <tr> <td>c</td> <td>25±2</td> </tr> <tr> <td>d</td> <td>Upper Temperature±2°C</td> </tr> <tr> <td>e</td> <td>25±2</td> </tr> </tbody> </table> <p>(1) Class I Temperature Coefficient shall be calculated from the formula as below $\text{Temp. Coefficient} = \frac{C2 - C1}{C1 \times \Delta T} \times 10^6 \text{ [ppm/°C]}$ C1: Capacitance at step c C2: Capacitance at 125°C $\Delta T: 100\text{°C}(=125\text{°C}-25\text{°C})$ Measuring Voltage: 0.5 to 5 Vrms</p> <p>(2) Class II Capacitance Change shall be calculated from the formula as below $\Delta C = \frac{C2 - C1}{C1} \times 100\%$ C1: Capacitance at step c C2: Capacitance at step b or d</p> | | Step | Temperature(°C) | a | 25±2 | b | Lower temperature±3°C | c | 25±2 | d |
| Step | Temperature(°C) | | | | | | | | | | | |
| a | 25±2 | | | | | | | | | | | |
| b | Lower temperature±3°C | | | | | | | | | | | |
| c | 25±2 | | | | | | | | | | | |
| d | Upper Temperature±2°C | | | | | | | | | | | |
| e | 25±2 | | | | | | | | | | | |
| Adhesion | IEC 60384-21/22 | 4.7 A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate | Force size 01005 : 1N | | | | | | | | | |
| Bending Strength | | 4.8 Mounting in accordance with IEC 60384-22 paragraph 4.3 Conditions: bending 1 mm at a rate of 1 mm/s, radius jig 5 mm | No visible damage <hr/> $\Delta C/C$ Class I (NP0): within $\pm 1\%$ or 0.5 pF, whichever is greater Class2 (X5R/X7R): $\pm 10\%$ | | | | | | | | | |

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
|------------------------------|----------------------|---|---|
| Resistance to Soldering Heat | 4.9 | Precondition: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature | Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned |
| | | Preheating: 120 °C to 150 °C for 1 minute and 170 °C to 200 °C for 1 minute. Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours | $\Delta C/C$ Class I (NP0): within ±0.5% or 0.5 pF, whichever is greater Class2 (X5R/X7R): ±10% D.F. within initial specified value R _{ins} within initial specified value |
| Solderability | 4.10 | Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds. | The solder should cover over 95% of the critical area of each termination |
| | | Test conditions for leadfree containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm | |
| Rapid Change of Temperature | IEC 60384-21/22 4.11 | Preconditioning; 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature | No visual damage |
| | | 5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours | $\Delta C/C$ Class I (NP0): within ±2.5% or 0.25 pF, whichever is greater Class2 (X5R/X7R): ±15% D.F. meet initial specified value R _{ins} meet initial specified value |

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
|-----------|-----------------|--|--|
| Damp Heat | with Ur load | 4.13 1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ± 1 hour at room temp 2. Initial measure: Spec: refer initial spec C, D, IR 3. Damp heat test: 500 ± 12 hours at 40 ± 2 °C; 90 to 95% R.H; 1.0 Ur applied. 4. Recovery: Class 1: 6 to 24 hours Class 2: 24 ± 2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and then the requirement shall be met. | No visual damage after recovery <hr/> Class 1 (NP0): $\Delta C/C$ within ±7.5% or 0.75 pF, whichever is greater D.F. $\leq 2 \times$ specified value I.R. $\geq 2,500 \text{ M}\Omega$ or $R_{ins} \times Cr \geq 25\Omega \cdot F$ whichever is less Class2 (X5R/X7R): $C \leq 1nF$ $\Delta C/C$ $\pm 15\%$ D.F. $\leq 10\%$ I.R. $\geq 500 \text{ M}\Omega$ $10nF \geq C > 1nF$ $\Delta C/C$ $\pm 20\%$ D.F. $\leq 10\%$ I.R. $\geq 500 \text{ M}\Omega$ $C > 10nF$ $\Delta C/C$ $\pm 25\%$ D.F. $\leq 20\%$ I.R. $R_{ins} \times Cr \geq 5\Omega \cdot F$ |

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
|---------------|----------------------|---|--|
| Endurance | IEC 60384-21/22 4.14 | <ol style="list-style-type: none"> Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp Initial measure: Spec: refer initial spec C, D, IR Endurance test: Temperature: NP0: 125 °C Specified stress voltage applied for 1,000 hours: Applied 2.0 × U_r for general product Temperature: X5R: 85°C, X7R: 125°C Specified stress voltage applied for 1,000 hours: Applied 1.5 × U_r for general product Recovery time: 24 ±2 hours Final measure: C, D, IR <p>P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and then the requirement shall be met.</p> | <p>No visual damage</p> <hr/> <p>Class 1 (NP0): ΔC/C within ±3% or 0.3 pF, whichever is greater D.F. ≤ 2 × specified value I.R. ≥ 4,000 MΩ or R_{ins} × Cr ≥ 40Ω · F whichever is less</p> <p>Class2 (X5R/X7R): C ≤ 1nF ΔC/C ±15% D.F. ≤ 10% I.R. ≥ 1GΩ</p> <p>10nF ≥ C > 1nF ΔC/C ±15% D.F. ≤ 10% I.R. ≥ 1GΩ</p> <p>C > 10nF ΔC/C ±25% D.F. ≤ 20% I.R. R_{ins} × Cr ≥ 10Ω · F</p> |
| Voltage Proof | IEC 60384-1 4.5.4 | <p>Specified stress voltage applied for 1~5 seconds U_r ≤ 100 V: series applied 2.5 U_r Charge/Discharge current is less than 50 mA</p> | No breakdown or flashover |

REVISION HISTORY

| REVISION | DATE | CHANGE NOTIFICATION | DESCRIPTION |
|------------|---------------|---------------------|---|
| Version 12 | Nov. 28, 2022 | - | - Change Range |
| Version 11 | Apr. 13, 2022 | - | - Change Range |
| Version 10 | May 5, 2017 | - | - Rated voltage of NPO series extend to 25 V - Add X5R, 470nF, 4V to 6.3V and 100nF, 10V |
| Version 9 | Jan. 17, 2017 | - | - Test condition updated |
| Version 8 | Jan. 12, 2016 | - | - Capacitance range & thickness update |
| Version 7 | Oct. 31, 2015 | - | - Capacitance range & thickness update |
| Version 6 | Jun. 29, 2015 | - | - Test procedures and requirements |
| Version 5 | Jun. 06, 2013 | - | - Test procedures and requirements |
| Version 4 | Mar. 27, 2013 | - | - Change Tolerance |
| Version 3 | Jan. 15, 2013 | - | - Change Range |
| Version 2 | Oct. 23, 2012 | - | - Change Range |
| Version 1 | July 03, 2012 | - | - Change Range |
| Version 0 | Apr 16, 2012 | - | - New |

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